# CMD75N68/CMU75N68



## **68V N-Channel MOSFET**

#### **General Description**

The 75N68 uses advanced technology and design to provide excellent R DS(ON) . This device is ideal for boost converters and synchronous rectifiers for consumer, telecom, industrial power supplies and LED backlighting.

### Features

- Max  $r_{DS(on)}$  =9.5m $\Omega$  at V<sub>GS</sub> = 10V
- Fast Switching
- RoHS Compliant

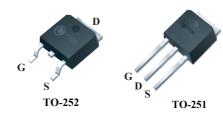
# **Product Summary**

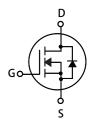
BVDSS	RDSON	ID
68V	9.5mΩ	70A

### Applications

- Inverters
- Power Supplies

# TO-252/251 Pin Configuration





Туре	Package	Marking
CMD75N68	TO-252	CMD75N68
CMU75N68	TO-251	CMU75N68

### **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units	
V <sub>DS</sub>	Drain-Source Voltage	70	V	
V <sub>GS</sub>	Gate-Source Voltage	±20	V	
I <sub>D</sub> @T <sub>C</sub> =25℃	Continuous Drain Current	70	А	
I <sub>D</sub> @T <sub>C</sub> =100 <sup>°</sup> C	Continuous Drain Current	56	A	
I <sub>DM</sub>	Pulsed Drain Current	280	A	
E <sub>AS</sub>	Drain-Source Avalanche Energy <sup>1</sup>	310	mJ	
P <sub>D</sub> @T <sub>C</sub> =25℃	Total Power Dissipation	90	W	
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	

# **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit	
R <sub>θJA</sub>	Thermal Resistance Junction-ambient		60	°C/W	
R <sub>θJC</sub>	Thermal Resistance Junction-case		1.4	°C/W	



### **68V N-Channel MOSFET**

#### Electrical Characteristics (T<sub>J</sub>=25 $^{\circ}$ C , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ =0V , I <sub>D</sub> =250uA	68			V
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =20A			9.5	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_{D}=250$ uA	2		4	V
I <sub>DSS</sub>	Drain-Source Leakage Current	$V_{DS}$ =68V, $V_{GS}$ =0V			1	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> =±20V , V <sub>DS</sub> =0V			±100	nA
gfs	Forward Transconductance <sup>2</sup>	V <sub>DS</sub> =10V, I <sub>D</sub> =20A		16		S
Qg	Total Gate Charge	I <sub>D</sub> =30A		67		
$Q_gs$	Gate-Source Charge	V <sub>DS</sub> =54V		18		nC
$Q_gd$	Gate-Drain Charge	V <sub>GS</sub> =10V		27		
T <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DS</sub> =34V		21		
Tr	Rise Time	I <sub>D</sub> =30A		59		
$T_{d(off)}$	Turn-Off Delay Time	R <sub>GEN</sub> =4.7Ω		58		ns
T <sub>f</sub>	Fall Time	V <sub>GS</sub> =10V		26		
Ciss	Input Capacitance			3500		
Coss	Output Capacitance	$V_{DS}$ =34V , $V_{GS}$ =0V , f=1MHz		184		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			183		

## **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current	$V_G = V_D = 0V$ , Force Current			70	А
I <sub>SM</sub>	Pulsed Source Current				280	А
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> =0V , I <sub>S</sub> =20A			1.2	V

Notes:

 $\label{eq:starting TJ = 25\,^{\circ}C}, \ L=0.5mH, I \mbox{ As =35A}, \ V \mbox{ DD = 30 V}, \ V \mbox{ Vs = 10 V}. \\ 2.\ Pulse Test: \ Pulse \ Width < 300 \mbox{ µs}, \ Duty \ cycle < 2.0\%. \\ \end{tabular}$ 

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